

STPS30SM60S

Power Schottky rectifier

Features

- High current capability
- Avalanche rated
- Low forward voltage drop
- High frequency operation

Description

The STPS30SM60S is a single Schottky diode, suited for high frequency switch mode power supply.

Packaged in TO-220AB, I²PAK and D²PAK, this device is intended to be used in notebook, game station and desktop adapters, providing in these applications a good efficiency at both low and high load.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	30 A
V _{RRM}	60 V
V _F (typ)	0.405 V
T _j (max)	150 °C

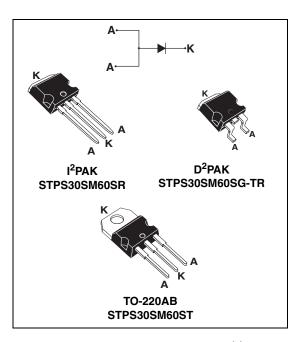
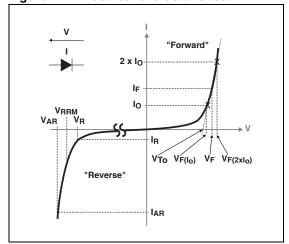


Figure 1. Electrical characteristics^(a)



a. V_{ARM} and I_{ARM} must respect the reverse safe operating area defined in *Figure 12*. V_{AR} and I_{AR} are pulse measurements ($t_p < 1~\mu s$). V_R , I_R , V_{RRM} and V_F , are static characteristics

October 2011 Doc ID 022029 Rev 1 1/9

Characteristics STPS30SM60S

Characteristics 1

Absolute ratings (limiting values with terminals 1 and 3 short circuited at Table 2. 25 °C, unless otherwise specified)

Symbol	Parameter				Value	Unit
V_{RRM}	Repetitive peak reverse voltage			60	V	
I _{F(RMS)}	Forward rms current				90	Α
I _{F(AV)}	Average forward current,	δ = 0.5	T _c = 125 °C	Per package	30	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sine-wave}$				600	Α
P _{ARM} ⁽¹⁾	Repetitive peak avalanche power $T_j = 25$ °C, $t_p = 1$ µs			28000	W	
V _{ARM} ⁽²⁾	Maximum repetitive peak avalanche voltage	t _p < 1 μs, T _j < 150 °C, I _{AR} < 105 A			80	V
V _{ASM} ⁽²⁾	Maximum single-pulse peak avalanche voltage	t _p < 1 μs, T _j < 150 °C, I _{AR} < 105 A			80	V
T _{stg}	Storage temperature range			-65 to +175	°C	
Tj	Maximum operating junction temperature ⁽³⁾			150	°C	

For temperature or pulse time duration deratings, please refer to Figure 4 and 5. More details regarding the
avalanche energy measurements and diode validation in the avalanche are provided in the application
notes AN1768 and AN2025.

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	1.0	°C/W

Table 4. Static electrical characteristics (terminals 1 and 3 short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage	T _j = 25 °C	V- - V	-	30	135	μΑ
current	T _j = 125 °C	$V_R = V_{RM}$	-	20	80	mA	
		T _j = 25 °C	I _F = 15 A	-	0.490	0.530	
V _F ⁽²⁾ Forward voltage drop	T _j = 125 °C	IF - 13 A	-	0.405	0.450	V	
	Forward voilage drop	T _j = 25 °C	I _F = 30 A	-	0.560	0.615	V
		T _j = 125 °C	IF - 30 A	-	0.500	0.570	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses use the following equation: P = 0.440 x $I_{F(AV)}$ + 0.0043 x $I_{F}^{2}_{(RMS)}$

$$P = 0.440 \times I_{F(AV)} + 0.0043 \times I_{F(RMS)}^{2}$$

See Figure 12

 $[\]frac{dPtot}{dTj} < \frac{1}{Rth(j-a)} \ \ condition \ to \ avoid \ thermal \ runaway \ for \ a \ diode \ on \ its \ own \ heatsink$

^{2.} Pulse test: t_p = 380 μ s, δ < 2%

STPS30SM60S Characteristics

Figure 2. Average forward power dissipation Figure 3. Average forward current versus versus average forward current ambient temperature (δ = 0.5)

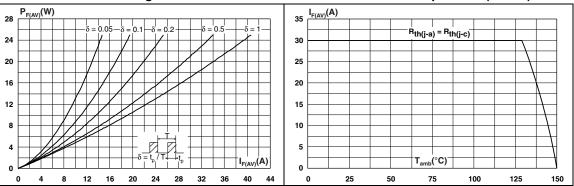


Figure 4. Normalized avalanche power derating versus pulse duration

Figure 5. Normalized avalanche power derating versus junction temperature

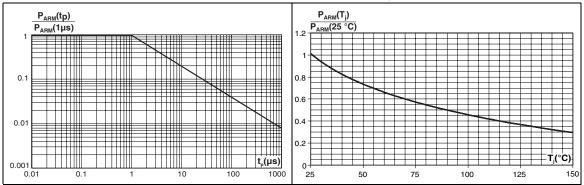
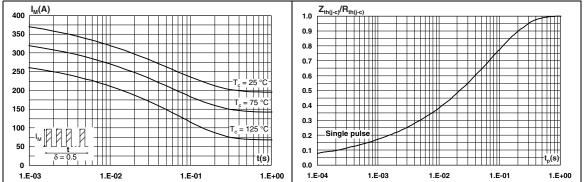


Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 7. Relative variation of thermal impedance junction to case versus pulse duration



Characteristics STPS30SM60S

Figure 8. Reverse leakage current versus reverse voltage applied (typical values)

Figure 9. Junction capacitance versus reverse voltage applied (typical values)

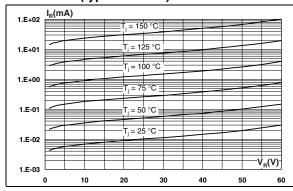
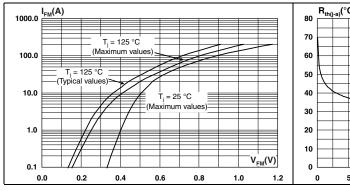


Figure 10. Forward voltage drop versus forward current

Figure 11. Thermal resistance junction to ambient versus copper surface under tab



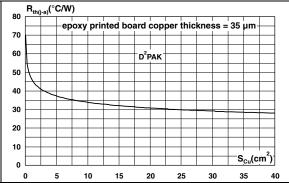
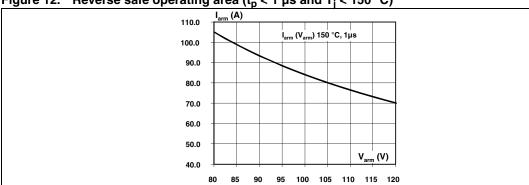


Figure 12. Reverse safe operating area (t_p < 1 μ s and T_i < 150 °C)



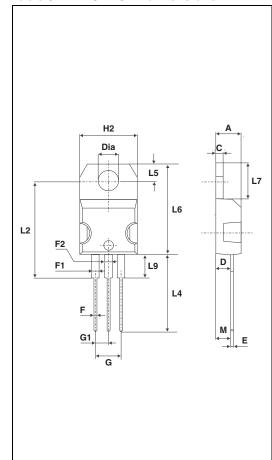
4/9 Doc ID 022029 Rev 1

2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of $\mathsf{ECOPACK}^{@}$ packages, depending on their level of environmental compliance. $\mathsf{ECOPACK}^{@}$ specifications, grade definitions and product status are available at: $\underline{\mathsf{www.st.com}}$. $\mathsf{ECOPACK}^{@}$ is an ST trademark.

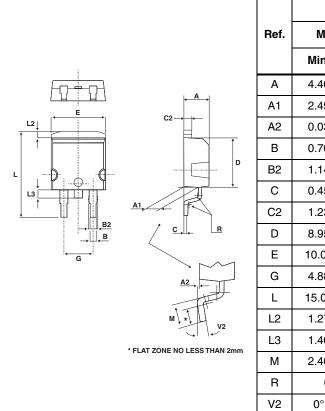
Table 5. TO-220AB dimensions



	Dimensions				
Ref.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	4.40	4.60	0.173	0.181	
С	1.23	1.32	0.048	0.051	
D	2.40	2.72	0.094	0.107	
Е	0.49	0.70	0.019	0.027	
F	0.61	0.88	0.024	0.034	
F1	1.14	1.70	0.044	0.066	
F2	1.14	1.70	0.044	0.066	
G	4.95	5.15	0.194	0.202	
G1	2.40	2.70	0.094	0.106	
H2	10	10.40	0.393	0.409	
L2	16.4	Тур.	0.645 Typ.		
L4	13	14	0.511	0.551	
L5	2.65	2.95	0.104	0.116	
L6	15.25	15.75	0.600	0.620	
L7	6.20	6.60	0.244	0.259	
L9	3.50	3.93	0.137	0.154	
М	2.6 Typ.		0.102	2 Typ.	
Dia.	3.75	3.85	0.147	0.151	

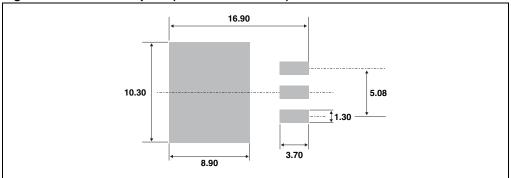
Package information STPS30SM60S

Table 6. D²PAK dimensions



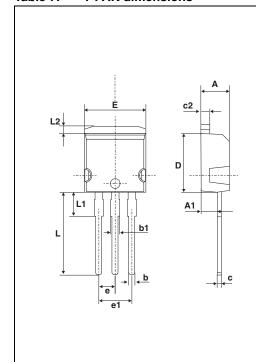
	Dimensions					
Ref.	Millim	neters	Inc	hes		
	Min.	Max.	Min.	Max.		
Α	4.40	4.60	0.173	0.181		
A1	2.49	2.69	0.098	0.106		
A2	0.03	0.23	0.001	0.009		
В	0.70	0.93	0.027	0.037		
B2	1.14	1.70	0.045	0.067		
С	0.45	0.60	0.017	0.024		
C2	1.23	1.36	0.048	0.054		
D	8.95	9.35	0.352	0.368		
Е	10.00	10.40	0.393	0.409		
G	4.88	5.28	0.192	0.208		
L	15.00	15.85	0.590	0.624		
L2	1.27	1.40	0.050	0.055		
L3	1.40	1.75	0.055	0.069		
М	2.40	3.20	0.094	0.126		
R	0.40 typ.		0.010	6 typ.		
V2	0°	8°	0°	8°		

Figure 13. D²PAK footprint (dimensions in mm)



6/9 Doc ID 022029 Rev 1

Table 7. I²PAK dimensions



	Dimensions				
Ref.	Millin	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	4.40	4.60	0.173	0.181	
A1	2.40	2.72	0.094	0.107	
b	0.61	0.88	0.024	0.035	
b1	1.14	1.70	0.044	0.067	
С	0.49	0.70	0.019	0.028	
c2	1.23	1.32	0.048	0.052	
D	8.95	9.35	0.352	0.368	
е	2.40	2.70	0.094	0.106	
e1	4.95	5.15	0.195	0.203	
Е	10	10.40	0.394	0.409	
L	13	14	0.512	0.551	
L1	3.50	3.93	0.138	0.155	
L2	1.27	1.40	0.050	0.055	

Ordering information STPS30SM60S

3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS30SM60ST	STPS30SM60ST	TO-220AB	2.2 g	50	Tube
STPS30SM60SR	STPS30SM60SR	I ² PAK	1.49 g	50	Tube
STPS30SM60SG-TR	STPS30SM60SG	D ² PAK	1.48 g	1000	Tape and reel

4 Revision history

Table 9. Revision history

Date	Revision	Changes
24-Oct-2011	1	First issue.

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Doc ID 022029 Rev 1

9/9